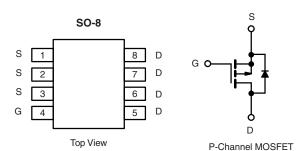


www.vishay.com

Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 40				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.014				
$R_{DS(on)}$ (Ω) at V_{GS} = - 4.5 V	0.023				
I _D (A)	- 17.3				
Configuration	Single				



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- AEC-Q101 Qualified
- 100 % Rq and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE

ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free and Halogen-free	SQ4401EY-T1-GE3

PARAMETER PARAMETER	, ,	SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	- 40	
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current ^a	T _C = 25 °C	l _D	- 17.3	A
	T _C = 125 °C		- 10	
Continuous Source Current (Diode Conducti	on) ^a	Is	- 6.5	
Pulsed Drain Current ^b		I _{DM}	- 69	
Single Pulse Avalanche Current	. 0.4	I _{AS}	- 30	
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	45	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	$T_{C} = 25 ^{\circ}C$ $T_{C} = 125 ^{\circ}C$ P_{D}	7.14	W
	T _C = 125 °C		2.4	
Operating Junction and Storage Temperatur	e Range	T _J , T _{stq}	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	85	°C/W	
Junction-to-Foot (Drain)		R_{thJF}	21	C/VV	

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR-4 material).



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							,
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0, I _D = - 250 μA		- 40	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = -250 \mu A$		- 2.0	- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = - 40 V	-	-	- 1.0	μА
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = - 40 V, T _J = 125 °C	-	-	- 50	
		$V_{GS} = 0 V$	V _{DS} = - 40 V, T _J = 175 °C	-	-	- 150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	V _{DS} ≥ - 5 V	- 30	-	-	Α
		V _{GS} = - 10 V	I _D = - 10.5 A	-	0.011	0.014	Ω
Drain Cauras On State Besistance	В	V _{GS} = - 10 V	I _D = - 10.5 A, T _J = 125 °C	-	-	0.020	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 10.5 A, T _J = 175 °C	-	-	0.024	
		V _{GS} = - 4.5 V	I _D = - 8.7 A	-	0.017	0.023	
Forward Transconductancea	9 _{fs}	$V_{DS} = -$	V _{DS} = - 15 V, I _D = - 10.5 A		30	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{GS} = 0 V V _{DS} = - 20 V, f = 1 MHz	-	3400	4250	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	440	550	
Reverse Transfer Capacitance	C _{rss}			-	350	436	
Total Gate Charge ^c	Qg			-	74	115	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 10 V	$V_{DS} = -20 \text{ V}, I_{D} = -10.5 \text{ A}$	-	11		nC
Gate-Drain Charge ^c	Q _{gd}			-	16]
Gate Resistance	R _g		f = 1 MHz		-	3.21	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	58	85	
Rise Time ^c	t _r	V_{DD} = - 15 V, R_L = 15 Ω I_D \cong - 1 A, V_{GEN} = - 4.5 V, R_g = 6 Ω		-	76	105	- ns
Turn-Off Delay Time ^c	t _{d(off)}			-	67	85	
Fall Time ^c	t _f			-	44	55	
Source-Drain Diode Ratings and Chara	acteristics ^b	•					
Pulsed Current ^a	I _{SM}			-	-	- 69	Α
Forward Voltage	V_{SD}	$I_F = -2.7 \text{ A}, V_{GS} = 0$		-	- 0.8	- 1.1	V

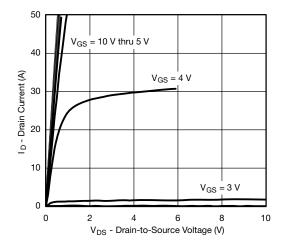
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

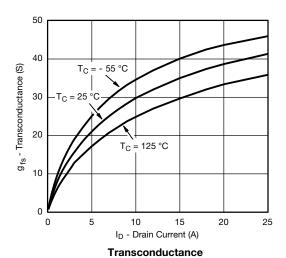
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

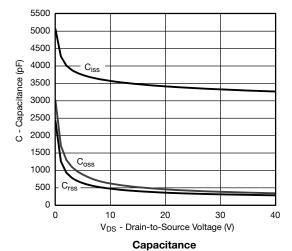


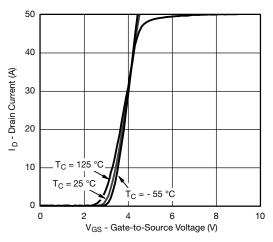
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



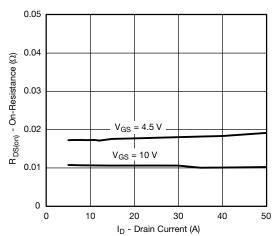
Output Characteristics



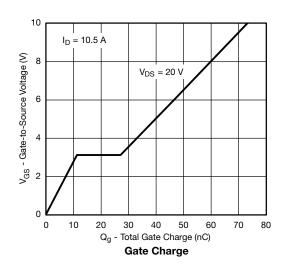




Transfer Characteristics

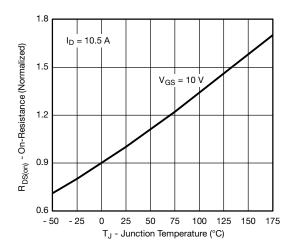


On-Resistance vs. Drain Current

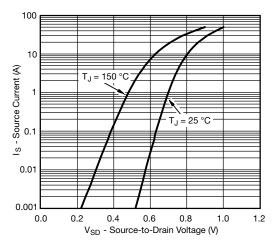




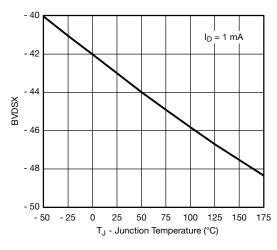
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



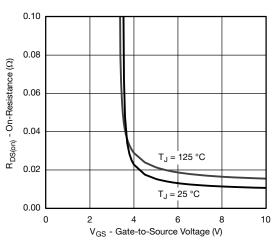
On-Resistance vs. Junction Temperature



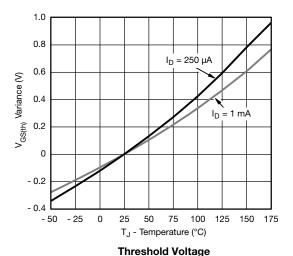
Source Drain Diode Forward Voltage



Breakdown Voltage vs. Junction Temperature

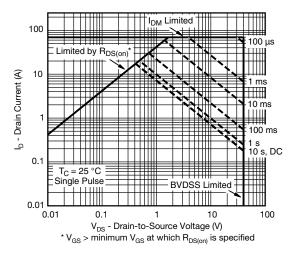


On-Resistance vs. Gate-to-Source Voltage

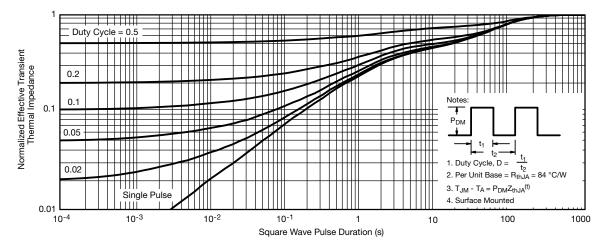




THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



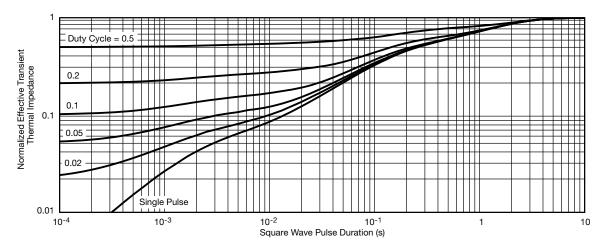
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65901.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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